

Lenovo P2 Tower Gen 2

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Product Name	P2 Tower Gen 2
Product Display Name	ThinkStation P2 Tower Gen 2
Information Date	11-Jun-25
Hardware Maintenance Manual	TBD
Drivers & Software	TBD
Available Whitepapers	TBD

SECTION I: Platform Overview

Description	Workstation performance is now within your reach with the Lenovo ThinkStation P2 Gen 2. Featuring the latest Intel Core Ultra processors (Series 2) with an integrated Neural Processing Unit (NPU), up to NVIDIA RTX 2000 Ada Generation professional graphics, PCIe Gen 5 support, and ultra-fast DDR5 memory, the ThinkStation P2 sets a new standard in the entry space while offering outstanding value.
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CPU

Processor Support	Intel Arrow Lake-S Series
Socket Type	Socket-V (LGA 1851)

Operating Systems

Preloaded	Windows 11 Pro 64-bit Windows 11 Home 64-bit Ubuntu 24.04 LTS
Supported	Red Hat Enterprise Linux Ubuntu 24.04 LTS

Memory

Slots	4
Channels	Supports up to 4 DIMM Sockets, 2 Channels
Type	DDR5 ECC and non-ECC UDIMM
ECC Support	Yes, CPU Dependent
Speed	Up to 5600MT/s
Max DIMM Size	32GB DDR5 UDIMM
Max System Memory	128GB
Disclaimers	*Memory speed impacted by number and type of DIMMs installed. *Memory speed can be dependent on the individual CPU capabilities.

Storage

Total Bays/Size	2 x 3.5" 2 x 2.5"
SATA	3 x SATA Connectors, Gen 3
PCIe	1 x M.2 2240/2280 PCIe Connector, Gen 5 Onboard (from CPU) 2 x M.2 2240/2280/2210 PCIe Connector, Gen 4 Onboard (from PCH) Additional M.2 2280 NVMe Drive Supported by Single Adapter, Gen 3
eSATA	1 x eSATA Connector, Gen 3
Disclaimers	Additional parts/enclosures may be required for some configurations. Refer to storage whitepaper for more details.

Video

Integrated Graphics	Intel Graphics (CPU dependent)
Discrete Graphics	Nvidia RTX A400 (miniDP x4) – 4GB GDDR6, PCIe4, Single-Slot Nvidia RTX A1000 (miniDP x4) – 8GB GDDR6, PCIe4, Single-Slot Nvidia RTX 2000 Ada (miniDP x4) – 16GB GDDR6, PCIe4, Dual-Slot
Multi-GPU Support	Yes
Type	PCIe Add-In-Card
Bus Interface	PCIe x16

Slots

Slot 1	PCIe 5.0 x16, Full Height, Full Length, 75W, With Latch
Slot 2	PCIe 3.0 x1, Full Height, Half Length, 25W, open-ended
Slot 3	PCIe 4.0 x4, Full Height, Half Length, 25W, With Latch
Slot 4	PCIe 3.0 x1, Full Height, Half Length, 25W, open-ended
Disclaimers	PCIe Slot 3 is a x16 mechanical slot, x4 electrical slot.

Front I/O

USB	2 x USB-A 3.2 Gen 2 (10Gb/s) 2 x USB-A 3.2 Gen 1 (5Gb/s) 1 x USB-C 3.2 Gen 2 (20Gb/s)
Audio	1 x Combo Audio Jack (3.5mm) 1 x Microphone Jack (3.5mm)
Media Card Reader	Optional: Front 3-in-1 Media Card Reader (USB 2.0)
Flex Bay	One 3.5" Flex Bay, Supports one of the following: – Flex storage enclosure – Front-access storage enclosure
Disclaimers	Actual USB throughput will vary depending on the type and quantity of USB devices used.

Rear I/O

USB	2 x USB-A 3.2 Gen 1 (5Gb/s) 2 x USB-A 2.0 (480Mb/s)
Audio	1 x Line Out
DisplayPort	2 x Standard DP 1.4 Optional 1 x DP 1.2 (CPU dependent), via flexible I/O port card
HDMI	1 x Standard HDMI 2.0 Optional 1 x HDMI 2.0 (CPU dependent), via flexible I/O port card
Type-C	Optional 1 x USB-C 3.1 Gen 1 (CPU dependent), via flexible I/O port card
VGA Port	Optional 1 x VGA Port (CPU dependent), via flexible I/O port card
Serial Port	Optional 1 x Serial Port Cable Optional 1 x Serial Port Expansion PCIe x1 Adapter
Ethernet	1 x 1GbE – RJ45

Parallel Port	Parallel Port Cable (300mm with ESD and 2.0 pitch)
Optional USB Adapter	Rear USB-C 3.2 Gen 2 PCIe x4 Adapter 2-Port USB 3.0 PCIe x1 Adapter Rear USB 2.0 Cable
Optional Network Adapter	Bitland RTL8125BGS Single Port PCIe x1 2.5Gigabit Ethernet Adapter Intel I210-T1 Single Port PCIe x1 Gigabit Ethernet Adapter Intel I350-T4 Quad Port PCIe x4 Gigabit Ethernet Adapter Intel Gale Peak 2 BE200 WiFi7 + Bluetooth 5.4 PCIe Adapter
Disclaimers	Actual USB throughput will vary depending on the type and quantity of USB devices used.

Ethernet

Vendor	Intel Jacksonville I219-LM (w/ AMT 16.x)
Speeds	10/100/1000 Mbps
Functions	PXE, ASF, WOL, Jumbo Frames, Teaming
Connectors	1 x RJ45

Audio

Vendor	Realtek
Type	Integrated Audio
Internal Speaker	Yes, 2W (8 ohms)
Connectors	2 x Front 3.5mm Jacks (Microphone & Headphone) 1 x Rear 3.5mm Jack (Line Out)
Chipset	ALC623-CG
Number of Channels	2
Number of Bits/Audio Resolution	6 channels of DAC support 16/20/24-bit PCM format for 5.1 audio solution

Thermal

Temp Sensors	Ambient Sensor VR Sensor Graphics Card Sensor (if applicable)
Fans	1 x CPU Fan 1 x Front Fan 1 x Rear Fan (optional) 1 x Power Supply Fan (inside PSU)

Power Specifications

Power Supply	750W	500W
Power Efficiency	92% Efficient @ 50% Load	92% Efficient @ 50% Load
Main	C14	C14
Operating Voltage Range	100 – 240V	100 – 240V
Rated Voltage Range	90-264VAC	90-264VAC
Rated Line Frequency	47Hz / 63Hz	47Hz / 63Hz
Operating Line Frequency Range	50Hz / 60Hz	50Hz / 60Hz
Rated Input Current	10A	7A
Graphics	1 x 8 pin (6+2)	1 x 8 pin (6+2)
Power Supply Fan	Yes	Yes
ENERGY STAR Qualified (config dependent)	Yes	Yes
80 PLUS Compliant	Yes	Yes
Built-in Self Test (BIST) LED	No	No
Aux Power Drop	Yes	Yes

BIOS

Vendor	AMI
Self-Healing BIOS	Yes

Chassis Information

Color	Raven Black
PSU	750W and 500W Available, Autosensing, 80 PLUS Platinum
Dimensions	376mm/14.80" H 170mm/6.69" D 315.35mm/12.41" W
Weight	8.65 kg / 19.07 lbs (starting weight) 13.61 kg / 30.00 lbs (maximum configuration)

Packaging Dimensions

Height (mm/in)	540mm / 21.26"
Width (mm/in)	280mm / 11.02"
Depth (mm)	420mm / 16.54"
Weight (kgs/lbs)	16.54 kg / 36.46 lbs

Security & Serviceability

TPM	Infineon SLB9672 TPM 2.0	
Asset ID	Yes, 1024 x 8bit	
vPro	Intel vPro for WS (AMT 16.x)	
Cable Lock Support	Yes, Optional Kensington Cable Lock	
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes	
Power-On Password	Yes	
Setup Password	Yes	
NIC LEDs (integrated)	Yes	
Access Panel Key Lock	No	
Boot Sequence Control	Yes	
Padlock Support	Yes	
Boot without keyboard and/or mouse	Yes	
Access Panel	Tool-less Side Cover Removal	
Optical Drive	Optional	
Hard Drives	Tool-less	
Expansion Cards	Tool-less	
Processor Socket	Tool-less	
Color coded User Touch Points	Yes	
Color-coordinated Cables and Connectors	Yes	
Memory	Tool-less	
System Board	Retained With Screws	
Restore CD/DVD/USB Set	Not Included, Restore Media Available via Lenovo Customer Support Center	

Operating Environment

Air Temperature	Operating: 10_C to 35_C (50_F to 95_F) Non-Operating: -40_C to 60_C (-40_F to 140_F)
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Storage	Storage: -40_C to 60_C (-40_F to 140_F) in Original Shipping Carton Storage: -10_C to 60_C (14_F to 140_F) Without Carton
Humidity	Operating Humidity: 10% to 90% (Humidity+EELP)
Altitude	Operating: 0m to 3048m (0ft to 10000ft) Storage: 0m to 12192m (0ft to 40000ft)
Vibration	Package Vibration: Random,1.04G at 2-200 Hz, 15 Minutes (X,Y,Z) axes Operating Vibration: Random,0.27G at 5-500 Hz, 30 Minutes Per Surface (X,Y,Z) axes Non-Operating Vibration: Random,1.04G at 2-200 Hz, 15 Minutes Per Surface 6 faces
Shock	Operating Shock: Half-sine wave, 15G/3ms(X,Y), 30G/3ms(Z) Rack Operating Shock: Half-sine wave, 15G/5ms Non-operating Shock: Trapezoidal wave, 45G/11ms
Disclaimers	Extended operating temperatures are possible – please contact your Lenovo Rep

SECTION II: Platform Detail

Board Size	10.51" x 9.72" (267mm x 247mm)
Layout	Custom ATX

Motherboard Core

Processor Support	Intel Arrow Lake-S Series
Socket Type	Socket-V (LGA 1851)
Memory Support	DDR5 up to 5600MT/s UDIMM Memory (ECC or non-ECC)
Voltage Regulator	125W TDP Capable
Chipset (PCH)	Intel W880 Chipset
Flash	Single 64MB
Super I/O	Nuvoton NCT6801D
Clock	Intel Native isCLK
Audio	Realtek ALC623-CG Codec
Ethernet	Intel Jacksonville I219-LM

Supported Components

Processor Level	Intel Arrow Lake
Processor	Intel Ultra 9 285K Intel Ultra 9 285 Intel Ultra 7 265K Intel Ultra 7 265 Intel Ultra 5 245K Intel Ultra 5 245 Intel Ultra 5 235 Intel Ultra 5 225
Memory Type	ECC/non-ECC UDIMMs – 5600MT/s
Memory	8GB DDR5 5600 MT/s non-ECC UDIMM 16GB DDR5 5600 MT/s ECC and non-ECC UDIMM 32GB DDR5 5600 MT/s ECC and non-ECC UDIMM
Disclaimers	*Memory speed dependent on CPU support.

Storage

3.5" SATA Hard Disk Drive (HDD)	2TB SATA HDD 7200rpm, 6Gb/s, 3.5" 2TB SATA HDD 7200rpm, 6Gb/s, 3.5" (enterprise class) 4TB SATA HDD 7200rpm, 6Gb/s, 3.5" (enterprise class) 6TB SATA HDD 7200rpm, 6Gb/s, 3.5" (enterprise class)
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M.2 PCIe Solid State Drive (SSD)	256GB M.2 (2280) PCIe SSD, Gen 4 x4, NVMe, OPAL 512GB M.2 (2280) PCIe SSD, Gen 4 x4, NVMe, OPAL 1024GB M.2 (2280) PCIe SSD, Gen 4 x4, NVMe, OPAL 2048GB M.2 (2280) PCIe SSD, Gen 4 x4, NVMe, OPAL 4096GB M.2 (2280) PCIe SSD, Gen 4 x4, NVMe, OPAL
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RAID

RAID Levels and Requirements	NVMe Drives Support RAID 0/1/5 SATA Drives Support RAID 0/1
Notes	Supported RAID levels for a system will vary from the stated capabilities of the RAID controller due to dependencies on the number and capacity of physical disks in the system and on customer requirements for performance, fault tolerance, or data redundancy.

Optical Drive/Removable Media

DVD-ROM Drive	Slim DVD-ROM drive
DVD Burner/CD-RW Drive	Slim DVD Burner/CD-RW Drive
Blu-Ray Burner Drive	Slim Blu-Ray ODD DVD Burner
Media Card Reader Specifications	Optional Front 3-in-1 USB 2.0 Media Card Reader

Keyboard and Pointing Devices

Keyboard	Traditional USB Keyboard Calliope USB Keyboard EOS Wireless Keyboard
Pointing Devices	Calliope USB Mouse

Expansion Bays

PCIe Adapters

Network	Intel I210-T1 Single Port PCIe x1 Gigabit Ethernet Adapter Intel I350-T4 Quad Port PCIe x4 Gigabit Ethernet Adapter RTL8125BGS Single Port PCIe x1 2.5Gigabit Ethernet Adapter
USB	USB-C 3.2 Gen 2 PCIe x4 Adapter (Single Port) USB 3.0 PCIe x1 Adapter (Dual Port)
WiFi Cards	Intel Gale Peak 2 BE200 WIFI7 + Bluetooth 5.4 PCIe
Parallel Card	4-Port Serial Expansion Card PCIe x1
PCIe to M.2 Adapter Card	PCIe x4 to M.2 Adapter – Gen 3

SECTION III: Supported Component Detail

CPU Specifications Part 1

CPU	Intel Core Ultra 9 285K	Intel Core Ultra 7 265K	Intel Core Ultra 5 245K	Intel Core Ultra 9 285
# of Cores	24c	20c	14c	24c
# of Threads	24	20	14	24
Processor Base Frequency	3.7GHz	3.9GHz	4.2Ghz	2.5GHz
Max Turbo Frequency	5.7GHz	5.5GHz	5.2Ghz	5.6GHz
Cache	36	30M	24M	36M
TDP	125W	125W	125W	65W
Intel ARK Spec Link	https://www.intel.com/content/www/us/en/products/sku/241060/intel-core-ultra-9-processor-285k-36m-cache-up-to-5-70-	https://www.intel.com/content/www/us/en/products/sku/241063/intel-core-ultra-7-processor-265k-30m-cache-up-to-5-50-	https://www.intel.com/content/www/us/en/products/sku/241067/intel-core-ultra-5-processor-245k-24m-cache-up-to-5-20-	

CPU Specifications Part 2

CPU	Intel Core Ultra 7 265	Intel Core Ultra 5 245	Intel Core Ultra 5 235	Intel Core Ultra 5 225
# of Cores	20c	14c	14c	10c
# of Threads	20	14	14	10
Processor Base Frequency	2.4GHz	3.5GHz	3.4GHz	3.3GHz
Max Turbo Frequency	5.3GHz	5.1GHz	5GHz	4.9GHz
Cache	36M	24M	24M	20M
TDP	65W	65W	65W	65W
Intel ARK Spec Link	https://www.intel.com/content/www/us/en/product/s/sku/241068/intel-core-ultra-7-processor-265-30m-cache-up-to-5-30-ghz/specifications.html	https://www.intel.com/content/www/us/en/product/s/sku/241876/intel-core-ultra-5-processor-245-24m-cache-up-to-5-10-ghz/specifications.html	https://www.intel.com/content/www/us/en/product/s/sku/241674/intel-core-ultra-5-processor-235-24m-cache-up-to-5-00-ghz/specifications.html	https://www.intel.com/content/www/us/en/product/s/sku/241070/intel-core-ultra-5-processor-225-20m-cache-up-to-4-90-ghz/specifications.html

HDD Specifications

Drive	2TB SATA – 7200rpm, 6Gb/s, 3.5"	4TB SATA – 7200rpm, 6Gb/s, 3.5" Enterprise	6TB SATA – 7200rpm, 6Gb/s, 3.5" Enterprise
3.5_ SATA Hard Disk Drive (HDD)	Yes	Yes	Yes
2.5_ SATA Hard Disk Drive (HDD)	Not Available	Not Available	Not Available
Connector	SATA	SATA	SATA
Transfer Rate (Gb/sec)	Average Data Rate, Read/Write 156MB/s	Sustained Data Transfer Rate 216-226MB/s	Sustained Data Transfer Rate 216-226MB/s
Spindle Speed (RPM)	7,200	7,200	7,200
Power Off to Spindle Stop (sec)	NA	NA	NA
DC Power to Drive Ready (sec)	<30.0	<30.0	<30.0
Average Latency (msec)	4.16	4.16	4.16
Input (VDC)	5 & 12	5 & 12	5 & 12
Typical (Watts)	5.6Max	9.5(Max)	11(Max)
Idle (Watts)	3.7Max	5.2(Max)	5.9(Max)
Physical Dimensions	101.6mm x 147mm x 26.1mm	101.85mm x 147mm x 26.1mm	101.85mm x 147mm x 26.1mm
Weight (grams)	<535	<715	<715
Operating (C) Ambient	0 to 55C	5 to 55	5 to 55
Operating (C) Base Casting	<60	<60	<60
Non-Operating (C) Ambient	(-40 to 70)	(-40 to 70)	(-40 to 70)
Gradient (C per Hour)	20	20	20
Operating (Gs @ 2ms)	80	Read 70 Gs / Write 40 Gs	Read 70 Gs / Write 40 Gs
Non-Operating (Gs @ 2ms)	300	250	250

Solid State Storage Specifications

Drive	NVMe 2280 M.2 Value 256GB M.2 NVMe OPAL	NVMe 2280 M.2 Value 512GB M.2 NVMe OPAL	NVMe 2280 M.2 Value 1TB M.2 NVMe OPAL	NVMe 2280 M.2 512GB PCIe SSD (OPAL)	NVMe 2280 M.2 1TB PCIe SSD (OPAL)	NVMe 2280 M.2 2TB PCIe SSD (OPAL)	NVMe 2280 M.2 4TB PCIe SSD (OPAL)
Dimensions Millimeters (W x D x H)	22 x 80 x 2.38	22 x 80 x 2.38	22 x 80 x 2.38	22 x 80 x 2.38	22 x 80 x 2.38	22 x 80 x 2.38	22 x 80 x 2.38
Interface Type	PCIe Gen 4x4	PCIe Gen 4x4	PCIe Gen 4x4	PCIe Gen 4x4	PCIe Gen 4x4	PCIe Gen 4x4	PCIe Gen 4x4
Power Active (AVG)	5.0W	5.0W	5.0W	5.8W	8W	8.25W	8.1W
Power Idle	40 mW	50 mW	50 mW	35 mW	35 mW	25mW	60mW
Typical Sequential Read	3300 MB/s	7000 MB/s	7000 MB/s	6800 MB/s	6900 MB/s	6900 MB/s	7000 MB/s
Typical Sequential Write	1250 MB/s	6600 MB/s	6600 MB/s	4400 MB/s	4800 MB/s	4800 MB/s	5200 MB/s
Burst Random Read (4K Queue Depth 32/8 thread);	200K IOPS	800K IOPS	800K IOPS	770K IOPS	820K IOPS	800K IOPS	850K IOPS

Burst Random Write (4K Queue Depth 32/8 thread)	400K IOPS	1300K IOPS	1300K IOPS	620K IOPS	650K IOPS	650K IOPS	620K IOPS
Operating Temperature Range	0 to 70C	0 to 70C	0 to 70C	0 to 55C	0 to 55C	0 to 55C	0 to 55C
Endurance Rating (Lifetime Writes)	85 TB	200 TB	400 TB	150 TB	300 TB	600 TB	2400TB
Mean Time Between Failures (MTBF)	1.5M POH	1.5M POH	1.5M POH	2.0M POH	2.0M POH	2.0M POH	1.5M POH
Hardware Encryption	AES 256 bit	AES 256 bit	AES 256 bit	AES 256 bit	AES 256 bit	AES 256 bit	AES 256 bit

Optical Drive Specifications

Description	9mm Slim DVD ROM Drive (SATA)	9mm Slim DVD Burner/CD-RW Drive (SATA)	9mm Slim Blu-Ray ODD DVD Burner (SATA)
Interface Type	SATA 1.5 Gb/s	SATA 1.5 Gb/s	SATA 1.5 Gb/s
Dimensions	1280.4×9.0 0.4×1270.4(Max) Unit:mm_Without Bezel-W x H x D)	1280.4×9.0 0.4×1270.4(Max) Unit:mm_Without Bezel-W x H x D)	1280.4×9.0 0.4×1270.4(Max) Unit:mm_Without Bezel-W x H x D)
Disc Capacity	NA	NA	NA
Type	DVDROM	DVDWriter	BD Rambo
External Dimensions	NA	NA	NA
Speed	NA	NA	NA
Bay Type	9.0mm Tray	9.0mm Tray	9.0mm Tray
Color	Business Black or without bezel	Business Black or without bezel	Business Black or without bezel
Removable	No	No	No
Internal Buffer Size	0.5MB Min	0.5MB Min	4MB
Writes	NA	8XDVD+R / 8XDVD+RW / 6XDVD+R DL 8XDVD-R / 6XDVD-RW / 6XDVD-R DL 24XCD-R / 16XCD-RW	6x BD-R / 2x BD-RE 8XDVD+R / 8XDVD+RW / 6XDVD+R DL 8XDVD-R / 6XDVD-RW / 6XDVD-R DL 5XDVD-RAM 24XCD-R / 16XCD-RW
Reads	8XDVD-ROM / 24XCD-ROM	8XDVD-ROM / 24XCD-ROM	6x BD-ROM / 8x DVD-ROM / 5x DVD-RAM / 24x CD-ROM
Source	DC Power 5V	DC Power 5V	DC Power 5V
DC Power Requirements	+5V5%	+5V5%	+5V5% Ripple less than 100mVp-p
DC Current	Max 2.5A@5v	Max 2.5A@5v	Max 2A@5v
Operating Systems Supported	Windows OS/Linux	Windows OS/Linux	Windows OS/Linux
Temperature	Operating: 5C to 45 C Non-Operating:-30C to 60C	Operating: 5C to 45 C Non-Operating:-30C to 60C	Operating: 5C to 45 C Non-Operating:-30C to 60C
Relative Humidity	Operating > Read: 15 % to 85 % (Non-Condensing) Write 15 % to 80 % (Depend on the Temperature) Storage/Transportation> 10 % to 80 % (Non-Condensing)	Operating > Read: 15 % to 85 % (Non-Condensing) Write 15 % to 80 % (Depend on the Temperature) Storage/Transportation> 10 % to 80 % (Non-Condensing)	Operating > Read: 15 % to 85 % (Non-Condensing) Write 15 % to 80 % (Depend on the Temperature) Storage/Transportation> 10 % to 80 % (Non-Condensing)

Integrated Graphics Adapter

Type	Intel Xe LPG Graphics
Bus Interface	Processor onboard
Display Interface	DP/DP/HDMI/DP or HDMI or Type-C or VGA(1 of 4 optional)
Video Resolution (max)	8K60 or 5K60 HDR max(2* 5K60 HDR or 4* 4K60 HDR)

Discrete Graphics Adapter

Adapter	NVIDIA RTX A400	NVIDIA RTX A1000	NVIDIA RTX2000 Ada
Bus Interface	PCI Express 4.0×16	PCI Express 4.0×16	PCI Express 4.0×8
Display Interface	DP *4	DP *4	mini DP *4
Graphics Chipset	PG172 SKU 570	PG172 SKU 550	PG192 SKU 570
Memory Clock Frequency (MHz)	6001 MHz	6001 MHz	7 GHz (max)

Memory Size	4GB GDDR6	8GB GDDR6	16GB
Memory Interface	64 bits	64 bits	128 bits
Memory Bandwidth	Up to 96 GB/s	Up to 192 GB/s	Up to 224 GB/s
GPU Cores	CUDA Cores: 768	CUDA Cores: 2048	NVIDIA Ada Lovelace architecture-based CUDA Cores:2816
GPU Core Frequency (MHz)	420MHz (base)/2100MHz (max boost)	1417MHz (base)/2100MHz (max boost)	Base:1620 MHz Boost:2130 MHz Maximum boost:3105 MHz
Maximum Power Consumption	30W	50W	70W
Supported Resolutions and Max Refresh Rates (Hz) (Note: Analog and/or Digital)	7680 x 4320 x 24 bpp @ 120Hz 7680 x 4320 x 24 bpp @ 60Hz 7680 x 4320 x 36 bpp @ 60Hz 5120 x 3200 x 24 bpp @ 60Hz 5120 x 2880 x 24 bpp @ 60Hz	7680 x 4320 x 24 bpp @ 120Hz 7680 x 4320 x 24 bpp @ 60Hz 7680 x 4320 x 36 bpp @ 60Hz 5120 x 3200 x 24 bpp @ 60Hz 5120 x 2880 x 24 bpp @ 60Hz	7680 x 4320 x 24 bpp @ 120Hz 7680 x 4320 x 24 bpp @ 60Hz 7680 x 4320 x 36 bpp @ 60Hz 5120 x 3200 x 24 bpp @ 60Hz 5120 x 2880 x 24 bpp @ 60Hz
Thermal Solution	Ultra-quiet Active Fansink	Ultra-quiet Active Fansink	Active cooled (blower fan)
Dimension	2.713 H x 6.137 L Single Slot, Low Profile	2.713 H x 6.137 L Single Slot, Low Profile	2.7 H x 6.6 L, Dual Slot
Advanced Display	Not Available	Not Available	Not Available
SLI/NVLink Support	Not Available	Not Available	Not Available

Ethernet Specifications Group 1 Part 1

Card	Intel I210-T1 Single Port Gigabit Ethernet Adapter (Springville)	Intel I350-T4 Quad Port Gigabit Ethernet Adapter (Stony Lake T4)	RTL8125BGS 2.5G Single Port PCIex1	Intel Wi-Fi 7 BE200 PCIe M.2 module SBB	Bitland RTL8168H 1000M PCIe HP	PCIe X1 RTL8125BS 2.5G Lan Card
Supplier PN	I210T1, MM# 941033	I350T4C1P20, MM# 928942	RTL8125BGS-CG	BE200 NGWG, MM# 99C462	5804-00001	LO1TH082-DT-R
Data Rates Supported	10/100/1000Mbps copper	10/100/1000Mbps (Copper), 1000Mbps (Fiber)	10/100/1000/2500Mbps copper	2.4G/5G/6G	10/100/1000Mbps copper	10/100/1000Mbps copper
Controller Details	Intel Ethernet Controller I210	Intel Ethernet Controller I351	Ethernet Controller RTL8125B	Intel Wi-Fi 7 BE200	REALTEK RTL8125BG	REALTEK RTL8125BG
Controller Bus Architecture	PCIe 2.1 (5GT/s)		PCIe 2.1 (5GT/s)		PCIe 2.1 (5GT/s)	
Data Transfer Mode	Ethernet	Ethernet	Ethernet	WLAN	Ethernet	Ethernet
Power Consumption	0.81W	Copper: I350T4V2= 5W LC-Fiber: I350F4= 6W	0.8W	M.2 power supply: supply: 3.3V worst case: 2000mA	0.8w	
IEEE Standards Compliance	IEEE 802.3/10BASE-T, 100BASE-TX, 1000BASE-T	IEEE 802.3/10BASE-T, 100BASE-TX, 1000BASE-T	IEEE 802.3 10BASE-Te, 1000/1000/2.5G BASE-T	IEEE 802.11 be IEEE 802.11 a/b/d/e/g/h/i/l/k/n/r/lu/v/w/ac/ax	IEEE 802.1P Layer 2 Priority Encoding IEEE 802.1Q VLAN tagging IEEE 802.3az Draft 3.2 (EEE)	IEEE 802.1P Layer 2 Priority Encoding IEEE 802.1Q VLAN tagging IEEE 802.3az Draft 3.2 (EEE)
Boot ROM Support	PXE boot, Intel iSCSI Remote Boot for Windows, Linux and Vmware, Intel BootAgent Software via PXE or BootP, WDMS or UEFI	PXE boot, Intel iSCSI Remote Boot for Windows, Linux and Vmware, Intel BootAgent Software via PXE or BootP, WDMS or UEFI	PXE /UEFI Boot	Wireless Functionality inPre-boot Environment WiFi UEFI	PXE boot	PXE boot
Network Transfer Mode (Full/Half Duplex)	Supported	Supported	Supported	NA	Supported	Supported
Network Transfer Rate	1,000Mbps Full Duplex	1,000Mbps Full Duplex	2500Mbps Full Duplex	NA	1,000Mbps Full Duplex	1,000Mbps Full Duplex
Operating System Driver Support	Windows 7/8/10, Linux, Free BSD, XEN,Vmware	Windows 7/8/10, Linux, Free BSD, XEN,Vmware	Windows 11 64	Windows11, Linux, Free BSD	Windows Server 2008, 2012, 2016, 2019 Linux (RHEL/SLES), Vmware	Windows 10 64-bit, Win10 IoT Win10 CSKU Linux Ubuntu/Redhat
Manageability	Supported	Supported	Supported	Supported	Supported	Supported
Manageability Capabilities Alerting	Supported	Supported	Supported	Supported	Supported	Supported
Lithography				NA		
TDP	Firmware Based Thermal Management		Firmware Based Thermal Management		Thermal Management	NA
Operating Temperature Range	0C to 55C (32F to 131F)	0C to 55C (32F to 131F)	-5...-50...[23F to 122F)	0C to 50C	0C to 55C (32F to 131F)	0C to 55C (32F to 131F)
# of Ports	1	4	1	NA	1	1
Data Rate Per Port	10/100/1000Mbps (copper)	10/100/1000Mbps (copper), 1000Mbps (fiber)	10/100/1000/2500Mbps	2*2	10/100/1000Mbps (copper)	10/100/1000Mbps (copper)
System Interface Type	PCIe Gen 2.1	PCIe Gen 2.1	PCIe Gen 2.1	M.2: PCIe*, USB	PCIe Gen 2.1	PCIe Gen 2.1
NC Sideband Interface	Not Available	Not Available	Not Available	Not Available	Not Available	Not Available
Jumbo Frames Supported	Yes	Yes	Yes	Yes	Yes	Yes
1000Base-T	Yes	Yes	Yes	NA	Yes	Yes

MACsec IEEE 802.1 AE		Coming Soon		Coming Soon		Not Available		NA
IEEE 1588	Supported	Supported		Supported		NA	Not Available	Not Available
Supported Under vPro	Not Available	Not Available		Not Available		Supported	Not Available	Not Available
Disclaimers	–	–		–		–	–	–

Ethernet Specifications Group 1 Part 2

Model	i210-T1	i350-T4	RTL8125BGS 2.5G Single Port PCIe x1	Intel Wi-Fi 7 BE200 PCIe M.2 module SBB	Bitland RTL8168H 1000M PCIe HP	PCIe X1 RTL8125BS 2.5G Lan Card
Connector	RJ-45 Copper	4 x Ports RJ-45 Copper	RJPA54-5JE3-M1A-0R	RF cable	1 Port RJ-45	RJ-45 Copper
Website	i210 T1	i350 T4	RTL8125BGS	BE200	IC Datasheet	IC Datasheet
Auto-Negotiation	IEEE* 802.3* Auto-negotiaton	IEEE* 802.3* Auto-negotiaton	suported	IEEE 802.11 be Auto-negotiaton	Auto-Negotiation with Next Page capability	IEEE* 802.3* Auto-negotiation
Intel vPro	Not Available	Not Available	Not Available	Supported	Not Available	Not Available
Intel Stable Image Platform Program (SIPP)				Not Available		
Intel Standard Manageability	Supported	Supported	Supported		Not Available	Not Available
Power Optimizer Platform Low-power Management Systems	Supported	Supported	Supported		Supported	Supported
Energy Efficient Ethernet	Supported	Supported	Supported	Supported	Supported	Supported
TCP/UDP Checksum and Segmentation Offload (IPv4 and IPv6)	Supported	Supported	Supported	Supported	Supported	Supported
Receive Side Scaling	Supported	Supported	Supported	Supported	Supported	Supported
Dual Tx and Rx Queues	Yes	Yes	Yes	Yes	Not Available	Not Available
Jumbo Frames (up to 9KB)	Supported	Supported	Jumbo Frames (up to 16KB)	Supported	Supported	Supported
Teaming	Supported	Supported	Supported	Supported	Supported	Supported
Integrated Switched Voltage Regulator (ISVR)				Yes		
Shared Flash with System BIOS				Not Available		
Wake from Deep Sx	Supported	Supported	Supported	Supported(S4)	Supported	Supported
Server Operating System Support	Windows Server 2008, 2012, 2016, 2019 Linux (RHEL/SLES), Free BSD, Xen, Vmware		Windows Server 2008, 2012, 2016, 2019 Linux (RHEL/SLES), Free BSD, Xen, Vmware		Windows Server 2008, 2012, 2016, 2019 Linux (RHEL/SLES), Vmware	Windows Server 2008, 2012, 2016, 2019 Linux (RHEL/SLES), Free BSD, Xen, Vmware
Network Proxy/ARP Support	Supported	Supported	Supported	Supported	Supported	Supported

Media Card Reader

Description	Media Card reader (3 in 1) TWR
Interface Type	USB2.0
Form Factor	USB 2.0 Mass Storage Device

SECTION IV: BIOS / Certifications / Standards / Environmental

BIOS Specifications

WMI Support	Compliant With Microsoft WBEM and the DMTF Common Information Model
ROM-Based Setup Utility (F1)	System Configuration Setup Program Available at Power-on With F1 Key
Bootblock Recovery	Recovers System BIOS if the Flash ROM Becomes Corrupted
Replicated Setup	Saves System Configuration Settings to a File That Can Then be Used to Replicate the Settings to Other Systems
Boot Control	Boot Control Available Through ROM-based Setup Utility or With F12 Key at Power-on
Memory Change Alert	Power-on Error Message in the Event of a Decrease in System Memory
Thermal Alert	Power-on Error message in the Event of a Fan Failure
Asset Tag	Supports Ability to Set SMBIOS Type 2 Baseboard Asset Tag Field

System/Emergency ROM Flash Recovery with Video	Supports Process to Recover the System BIOS if the Flash ROM Becomes Corrupted
Remote Wakeup/Remote Shutdown	System Admin Can Power On/Off a Client Computer from a Remote Location to Provide Maintenance
Quick Resume Time	Supports Low Power S3 (suspend to RAM) and Prompt Resume Times
ROM Revision Level	System UEFI (BIOS) Version Reported in SMBIOS Type 0 Structure and in BIOS Setup
Keyboard-less Operation	System Can be Booted Without a Keyboard
Per-port Control	Allows I/O Ports to be Individually Enabled/Disabled Through ROM-based Setup or WMI Interface
Adaptive Cooling	Offers Multiple Settings for Fan Control Ranging Between Better Performance and Better Acoustics
Security	Supervisor, SMP and Power-On Passwords Can Protect Boot and ROM-based Setup - Support Electronic Lock - Chassis Intrusion Detection - UEFI Secure Boot Support - HDD Password Can Protect HDD Data - Windows UEFI Firmware Update Support - Device Guard Support - Optional Access Panel Lock, Kensington Lock, and Pad Lock, BIOS Guard, Boot Guard - BIOS Self-Healing Gen 2 (RoT: EC) - Secure Wipe 2.0 - Subscription Certificate Storage - Certificate-based BIOS Authentication and Management Phase 2 - BIOS Modification and Event Logging - Phase 1 - Customized BIOS Defaults - BIOS Settings in Intune Settings Catalog - Microsoft Modern (Cloud) Bare Metal Recovery "cBMR" - BIOS Initialization to Factory Default
Intel(R) AMT (includes ASF 2.0)	Allows System to be Supported from a Remote Location
Intel(R) TXT	Intel(R) Trusted Execution Technology Provides a Security Foundation to Build Protections Against Software Based Attacks
Memory Modes	Supports Mirroring, Lock Step, and Sparing Memory Modes
Windows 10 Ready	Supports Windows 10 Requirements for Secure Flash, UEFI v 2.8 Device Guard Support Spec

Industry Standard Specification Support

UEFI	Unified Extensible Firmware Interface v2.78
ACPI (Advanced Configuration and power Management Interface)	Advanced Configuration and Power Interface v6.2
ASF 2.0	DMTF Alert Standard Format Specification v2.0
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6)
CD Boot	EI Torito Bootable CD-Rom Format Specification, v1.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision v1.0
PCI	NA (No PCI slot)
PCI Express	PCI Express Base Specification v4.0
SATA	Serial ATA Revision 3.0 Specification
TPM	Trusted Computing Group TPM Specification v2.0
UHCI	Universal Host Controller Interface Design Guide, Revision v1.1
USB	Universal Serial Bus Revision v1.1 Universal Serial Bus v2.0 Universal Serial Bus v3.0 Universal Serial Bus v3.2
SMBIOS	DMTF System Management Spec v3.2.1
XHCI	XHCI SPEC Revision v1.2

Social and Environmental Responsibility

Quality Control	Lenovo is a member of an eco declaration system that enforces regular independent quality control
Hazardous Substances and Preparation	CDX Scip control
Batteries	UN38.3,MSDS
Safety, EMC Connection to the Telephone Network and Labeling	Not applicable

Acoustic Noise Emissions Declaration

LWAd(bels) Idle	3,6
LWAd(bels) Oper	3,6

Safety, EMC Connection to the Telephone Network and Labeling

Industry Standard Specifications	not applicable
Remote Manageability Software Solutions	not applicable
System Software Manager	Lenovo ThinkStation supports software management tools by Lenovo Vantage.

Regulations & Standards

EMC & Safety	FCC/IC VCCI BSMI KC RCM CS UL IEC62368 CB Report/Certificate Saudi Arabia EQM Kuwait KUCAS China CCC Mark Singapore PSB South Africa SABS Russia/Belarus/Kazakhstan/Kyrgyzstan/Armenia-EAC Morocco-CM Mexico-NOM Serbia KVALITET Ukraine UKrCEPRO India-BIS China SRRC Indonesia-DJID Malaysia-SIRIM Philippines-NTC Chile-SUBTEL Thailand-NBTC Morocco-ANRT Singapore-IMDA India-ETA
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Environmentals

Energy Star	ENERGY STAR 9.0
EPEAT	EPEAT Certification Available on Select Models
ErP Lot-3 2013	Yes
Hazardous Substances	CDX Scip control
Materials Used	System 95% PCC recycled plastic front bezel Packaging Carton: 90% Recycled and/or FSC certified content3 Cushion: 90% Recycled EPE
TCO Certification	10.0
Disclaimers	EPEAT registered where applicable. EPEAT registration varies by country. See www.epeat.net for registration status by country.